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# SIC DETECTORS TO MONITOR IONIZING RADIATIONS EMITTED FROM NUCLEAR EVENTS AND PLASMAS



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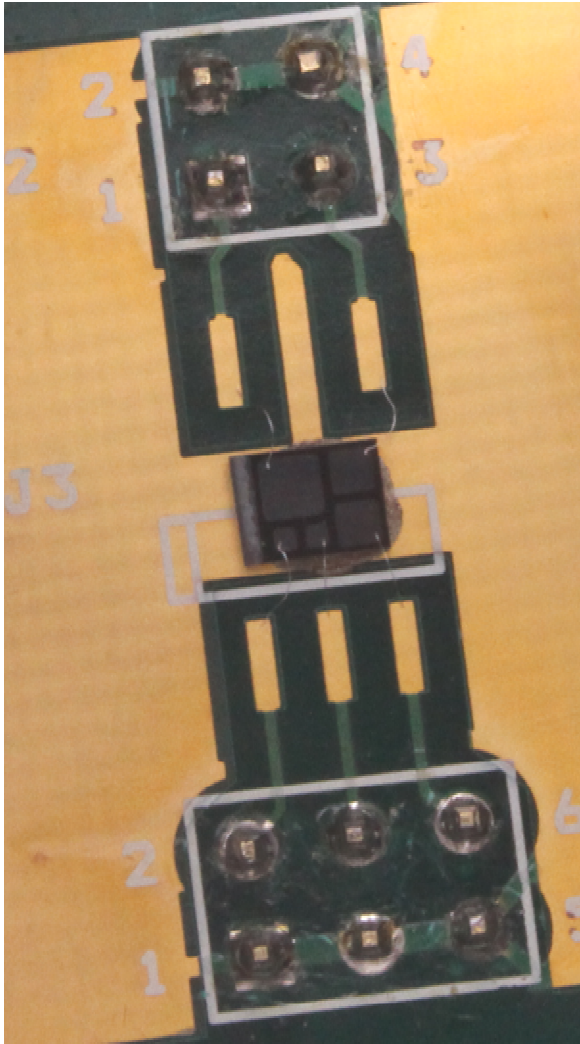
# OUTLINE



- ❑ Properties of Silicon Carbide
- ❑ Characterization of a SiC diode at low fluence for:
  - $\alpha$ -particles
  - electrons
  - X-rays
- ❑ Time of Flight (TOF) technique in plasmas generated by laser producing high radiation fluence
- ❑ First study for SiC applications in radiation dosimetry
- ❑ Conclusions



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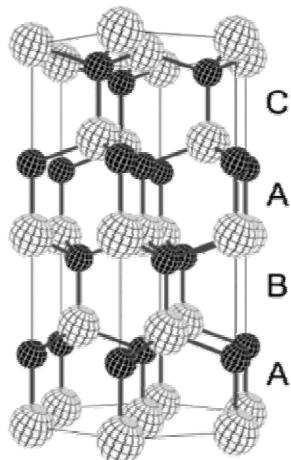
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**Preliminary**



# INTRODUCTION: WHY SILICON CARBIDE?

Physical property	4H-SiC	Silicon	GaAs	Diamond
Crystal structure	Hexagonal	Diamond	Zinc-blende	Diamond
Band gap [eV]	3.26	1.12	1.43	5.45
Density [g/cm <sup>3</sup> ]	3.21	2.33	5.32	3.52
Electron mobility [cm <sup>2</sup> /Vs]	800-1000	1450-1500	8500	1800-2200
Holes mobility [cm <sup>2</sup> /Vs]	100-115	450-600	400	1200-1600
Breakdown electric field [MV/cm]	2.2-4.0	0.2-0.3	0.3-0.6	10
Mean e-h pair energy [eV]	7.78	3.63	4.21	13
Thermal conductivity [W/cm °C]	3.0-5.0	1.5	0.5	20
Max working temperature [°C]	1240	300	460	1100
Effective atomic number	12.54	14	32.06	6
Displacement energy [eV]	25	13-20	15.5	43

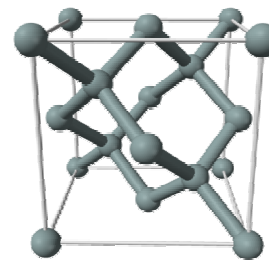


4H-SiC

Si-C 1.89 Å

Si-Si & C-C 3.08 Å

Interatomic distances



Silicon

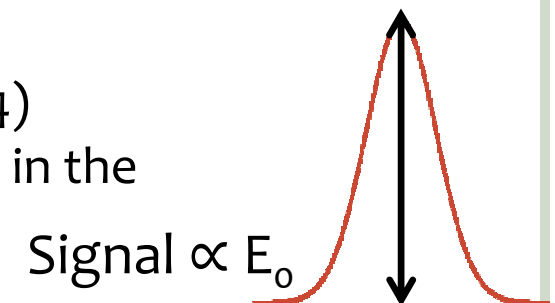
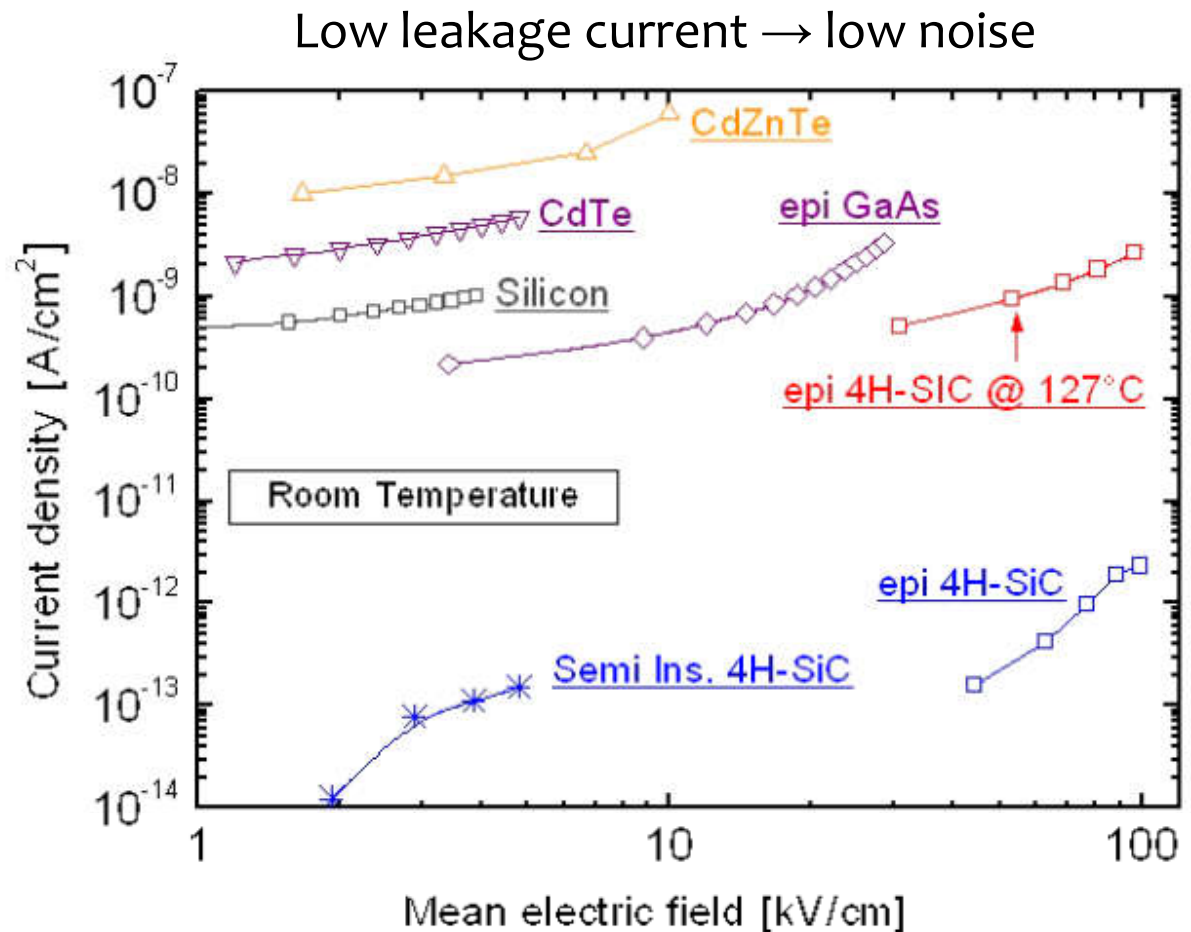
Si-Si 2.35 Å





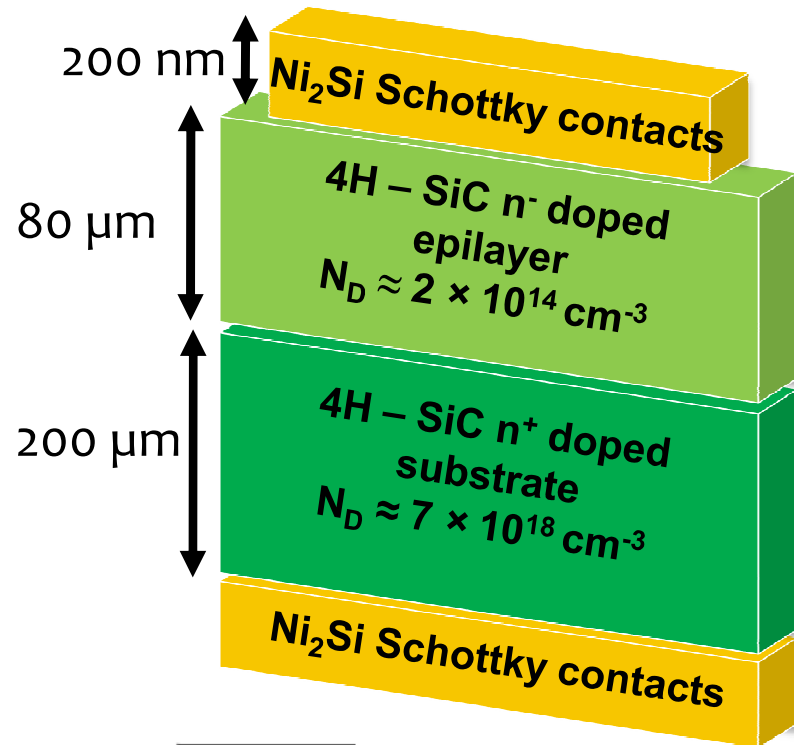
# ADVANTAGES OF SiC RESPECT TO TRADITIONAL SI DETECTOR

1. SiC reverse current is a factor 10 - 100 lower than Silicon at room temperature → increase sensibility
2. The high energy gap makes this detector blind to visible radiation → remove the shielding systems
3. The higher thermal conductivity → increase the maximum working temperature up to 1200 °C vs. 300 °C for Si
4. Higher displacement energy threshold → a better radiation hardness
5. Effective atomic number is closer in SiC (12.5) than Silicon (14)
6. High linearity between the signal pulse and energy released in the active region of the device



# DETECTOR STRUCTURE

Single crystal 4H-SiC Schottky diode



$$W = \sqrt{\frac{2\epsilon_0\epsilon_r V}{qN_D}}$$

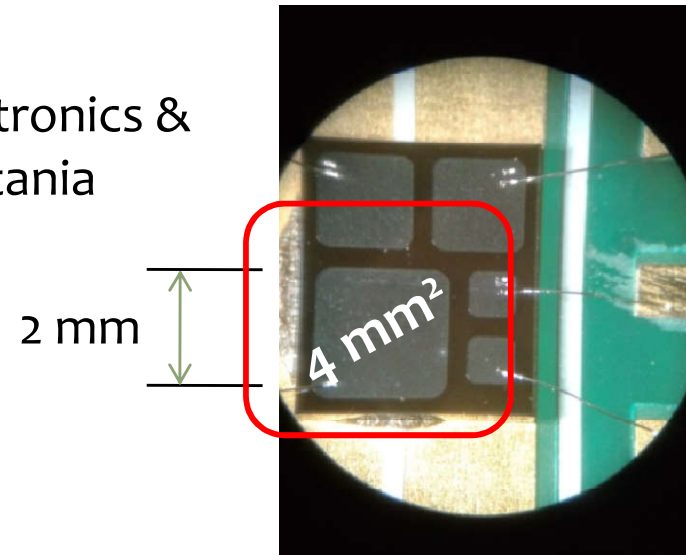
$\epsilon_r$  = relative permittivity = 9.66

$N_D$  = doping concentration =  $2 \times 10^{14} \text{ cm}^{-3}$

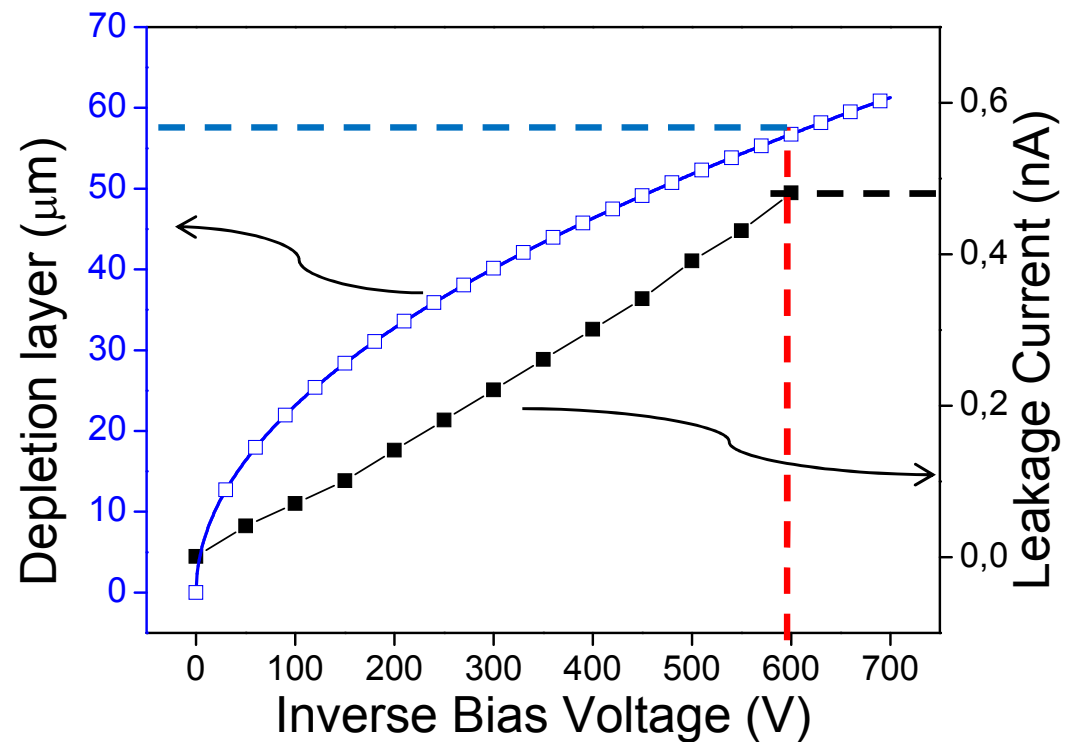
$q$  = elementary charge

$V$  = inverse bias voltage

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Optical microscope image

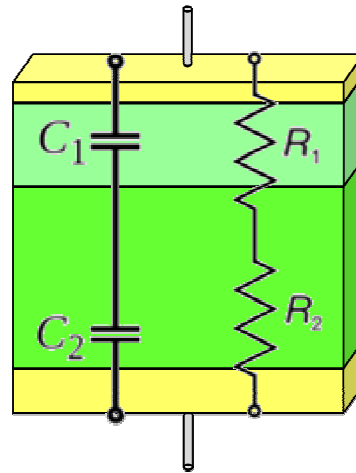


# RESISTANCE AND CAPACITANCE

$$C = \epsilon_0 \epsilon_r \frac{A}{W} = A \sqrt{\frac{q \epsilon_r \epsilon_0 N_D}{2V}}$$

$A$  = diode surface = 4 mm<sup>2</sup>

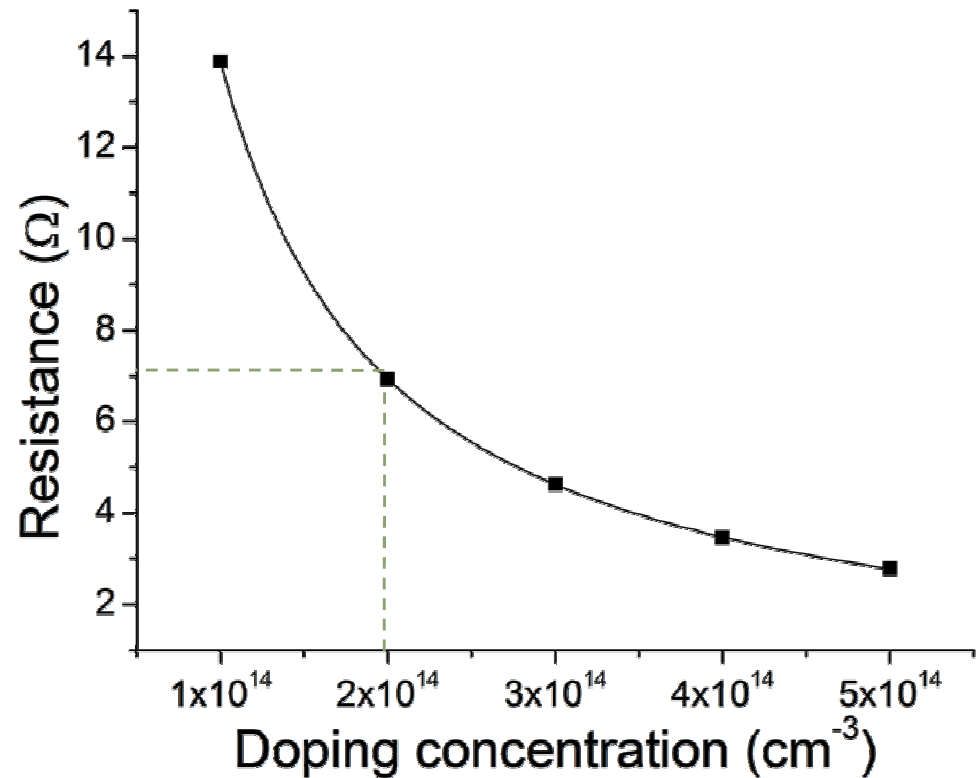
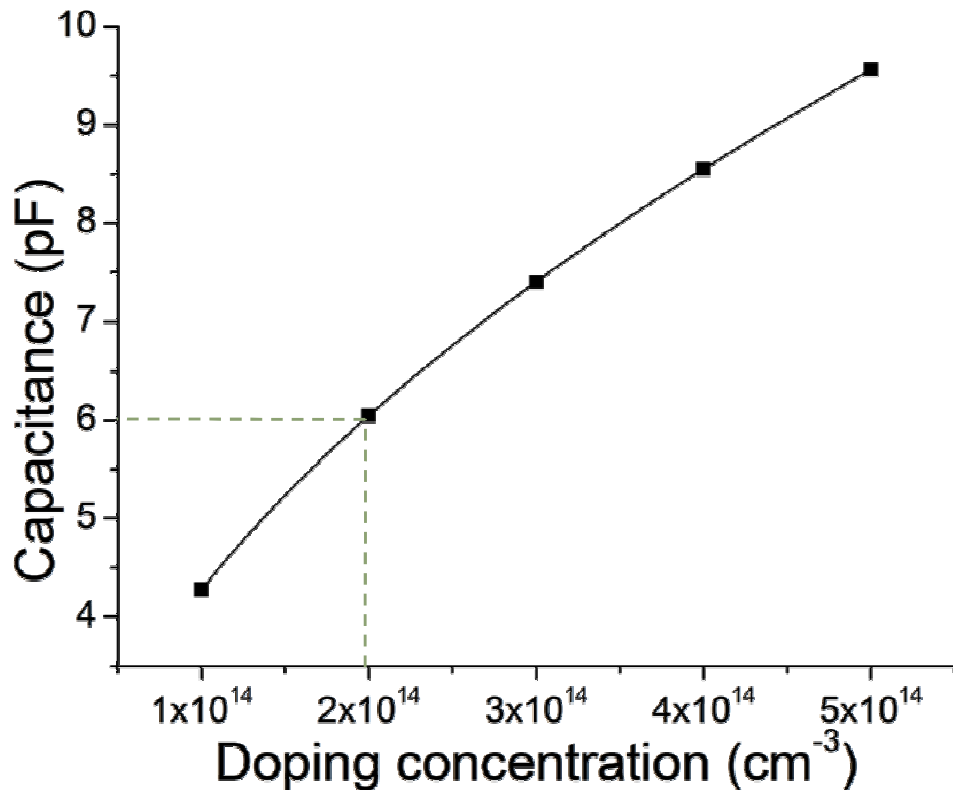
$N_D = 2 \times 10^{14} \text{ cm}^{-3}$



$$R = \rho \frac{W}{A} = \frac{1}{q \mu_e N_D} \frac{W}{A}$$

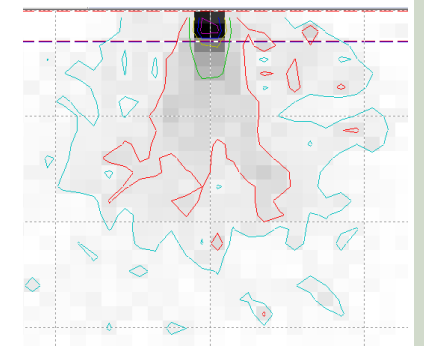
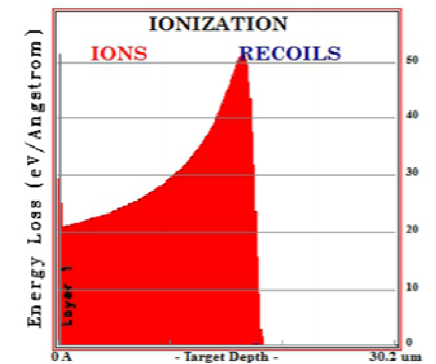
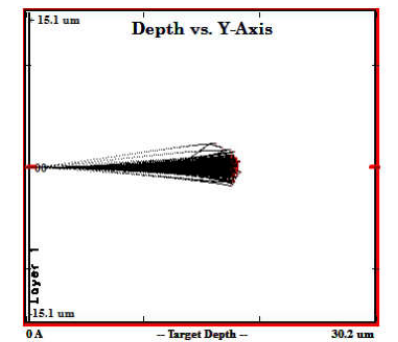
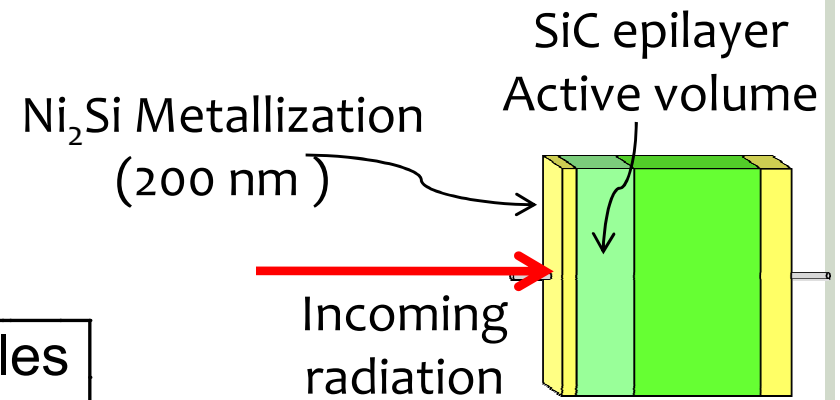
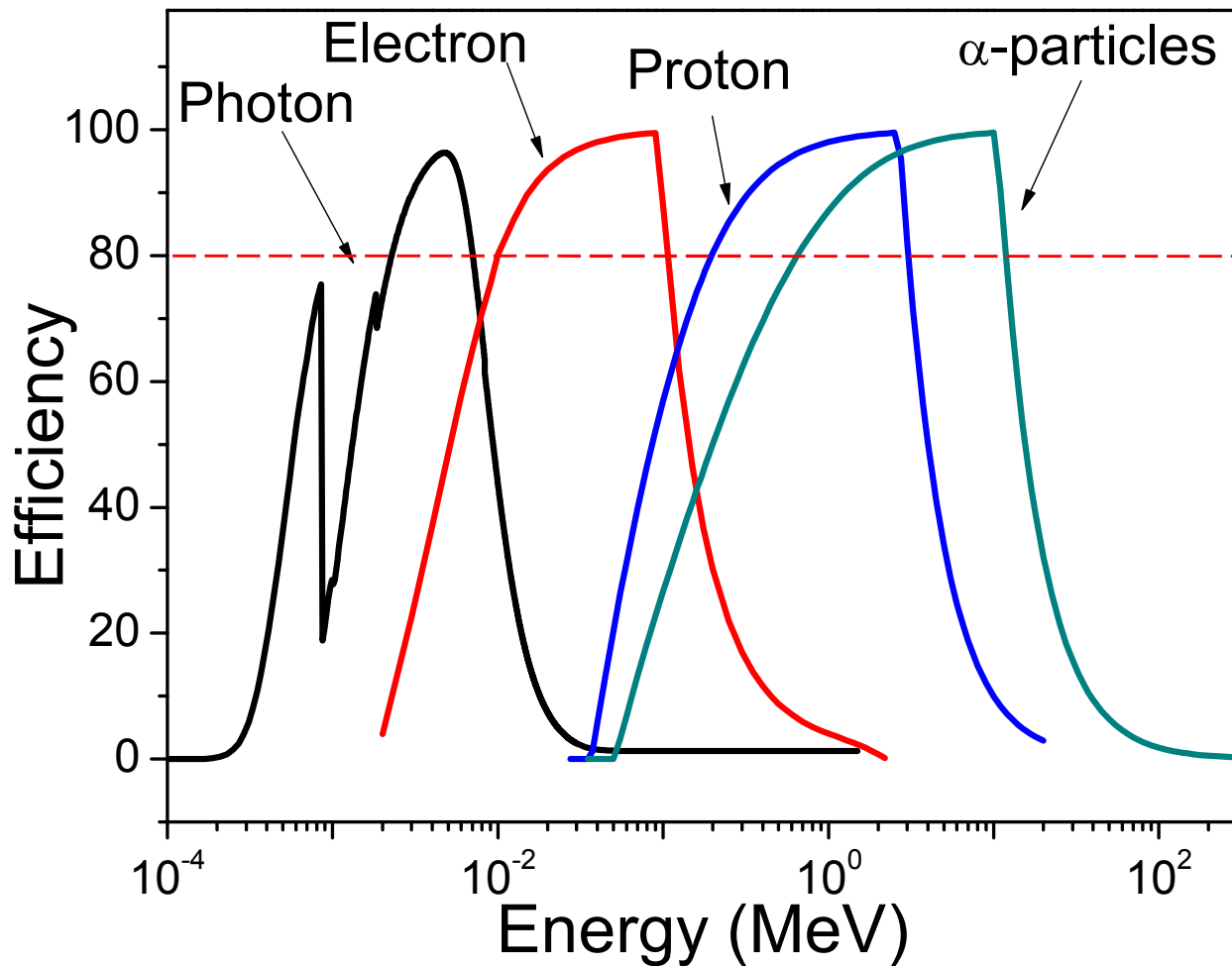
$\mu_e = 900 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$   
electron mobility

$\rho$  = resistivity



# SIMULATED EFFICIENCY

Active region = 80  $\mu\text{m}$

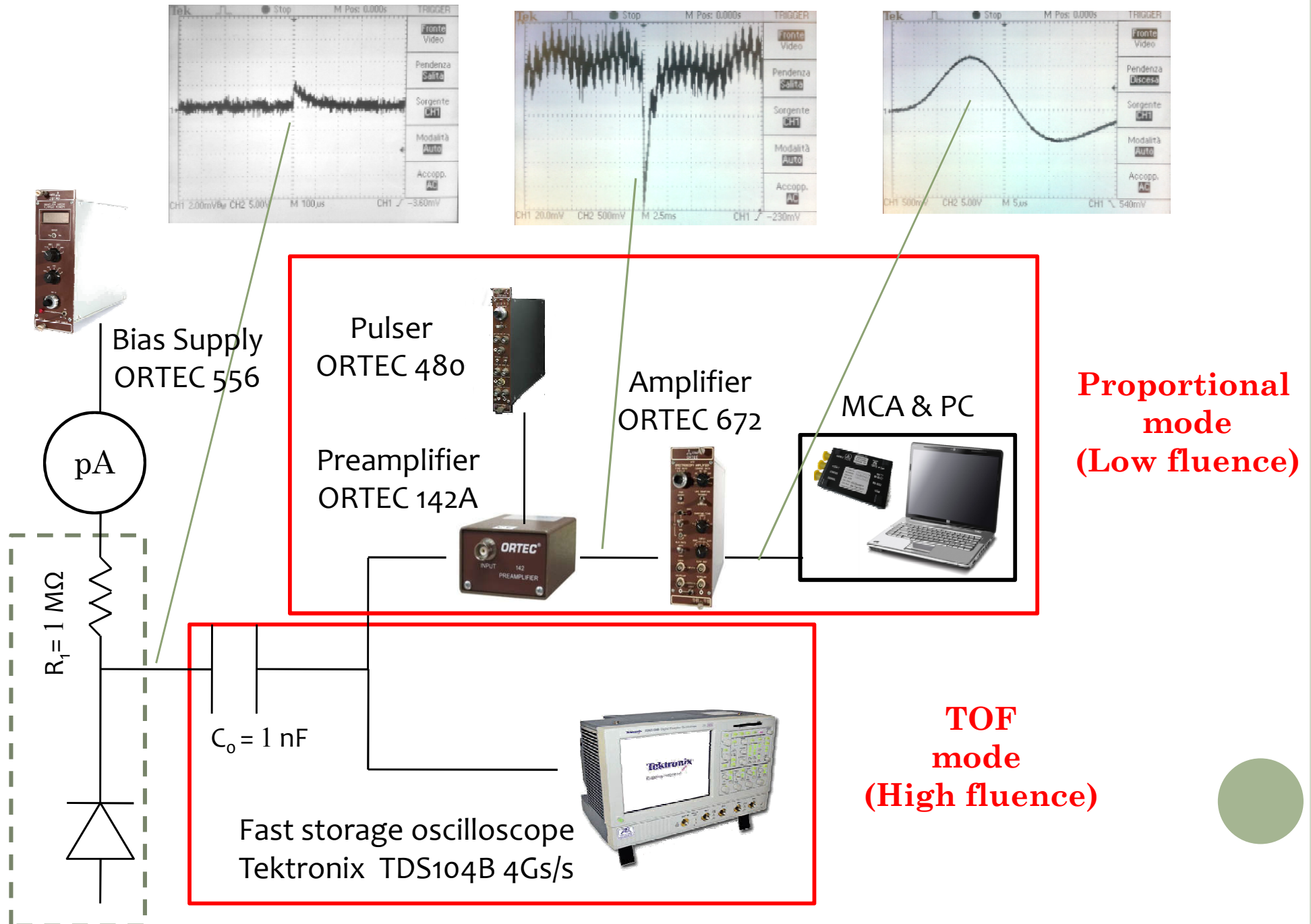


CXRO for photon: [http://henke.lbl.gov/optical\\_constants/filter2.html](http://henke.lbl.gov/optical_constants/filter2.html)

eSTAR for electron: <http://physics.nist.gov/PhysRefData/Star/Text/ESTAR.html>

SRIM2008 for proton and heavier positive ions: <http://www.srim.org/>

# EXPERIMENTAL SET-UP

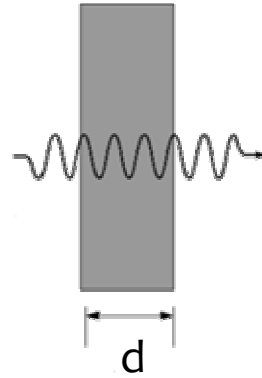


# $\alpha$ -PARTICLES SPECTROSCOPY

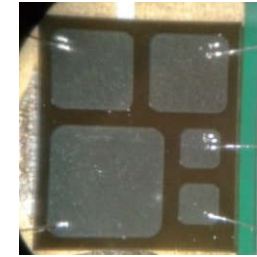


Mylar absorber

$\alpha$  - Source



detector



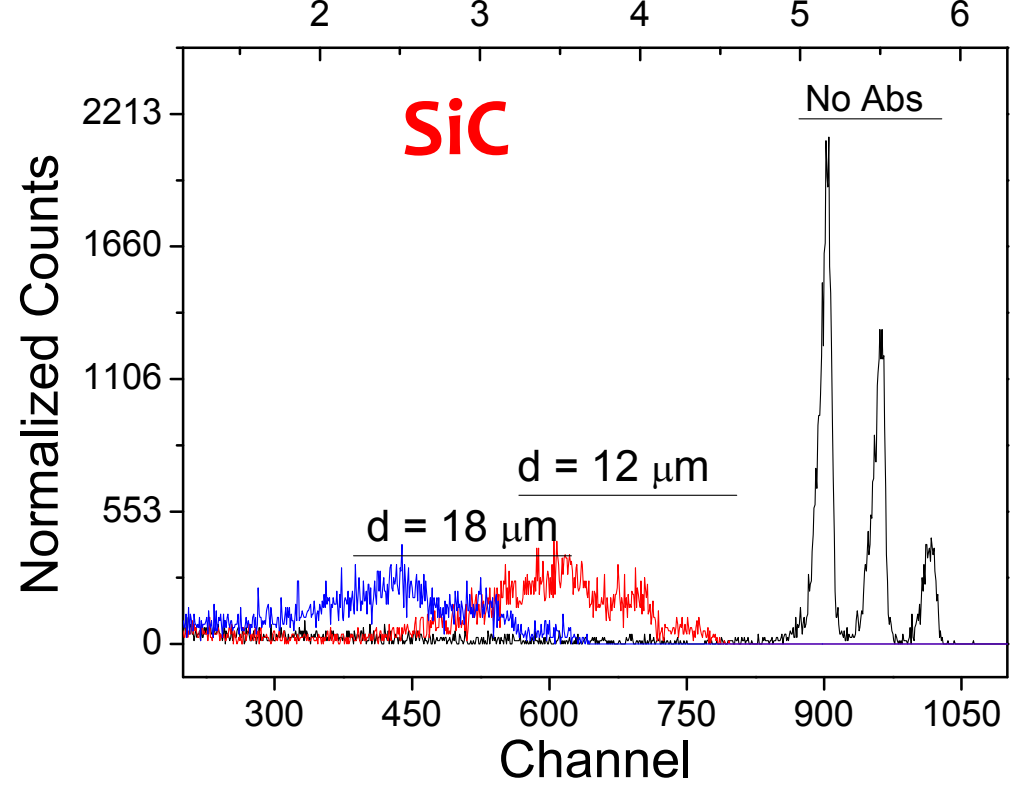
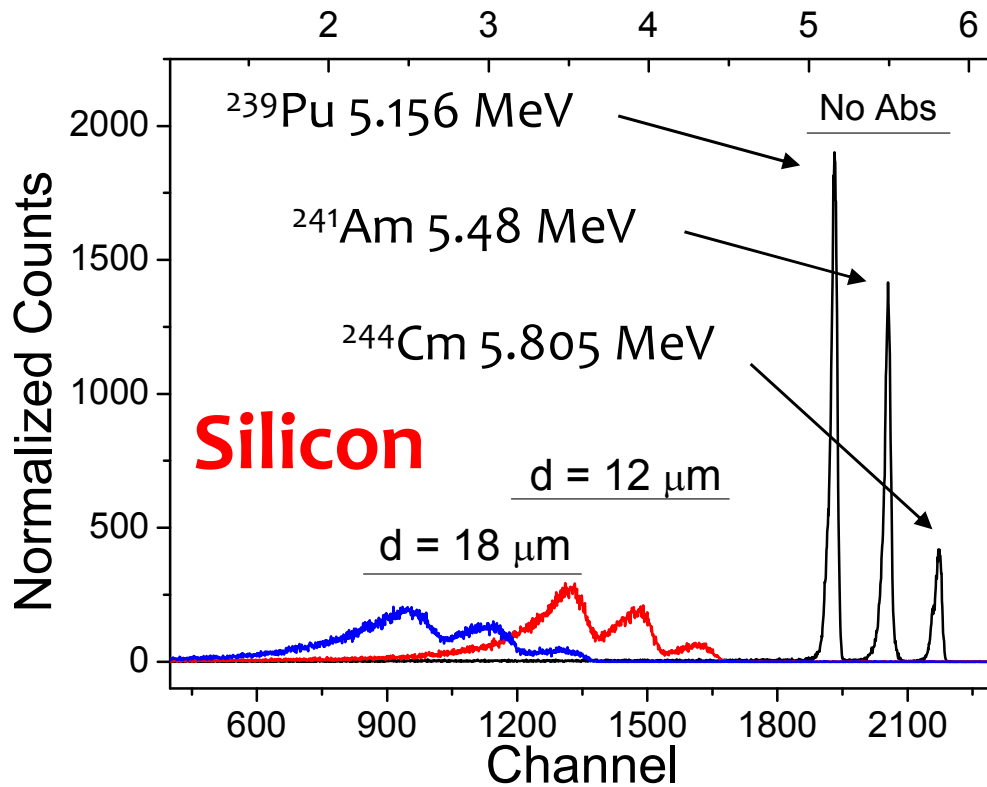
Detector Bias = + 50 V  
 Time = 300s  
 Source detector distance = 6mm  
 Surface of diode = 0.5 cm<sup>2</sup>  
 Detection Solid angle = 8.3 msr

Detector Bias = -200V  
 Time = 300s

Source detector distance = 6mm  
 Surface of diode = 0.04 cm<sup>2</sup>  
 Detection Solid angle = 0.6 msr

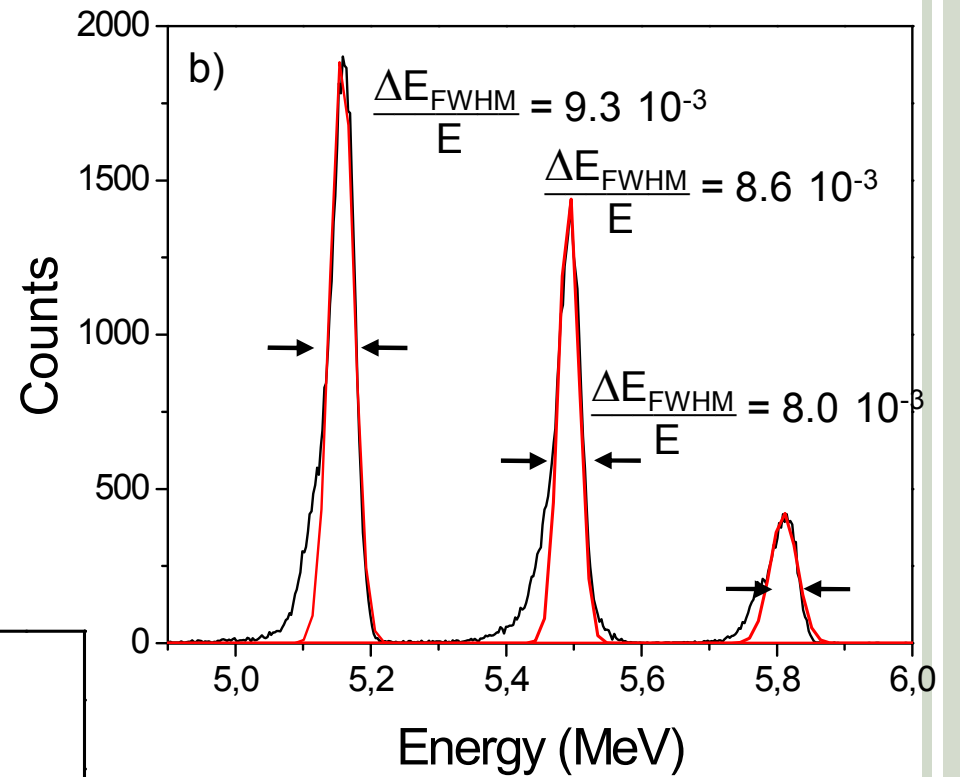
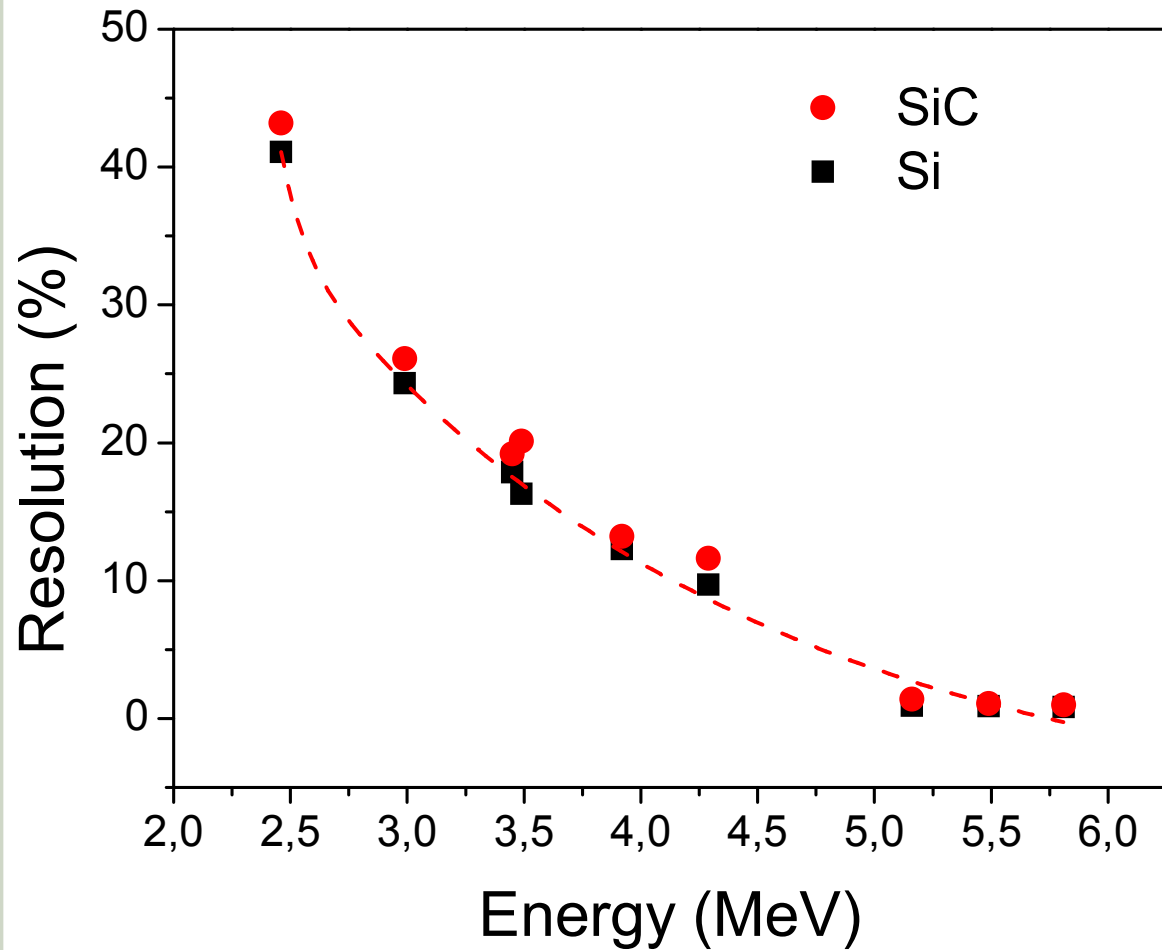
Energy (MeV)

Energy (MeV)



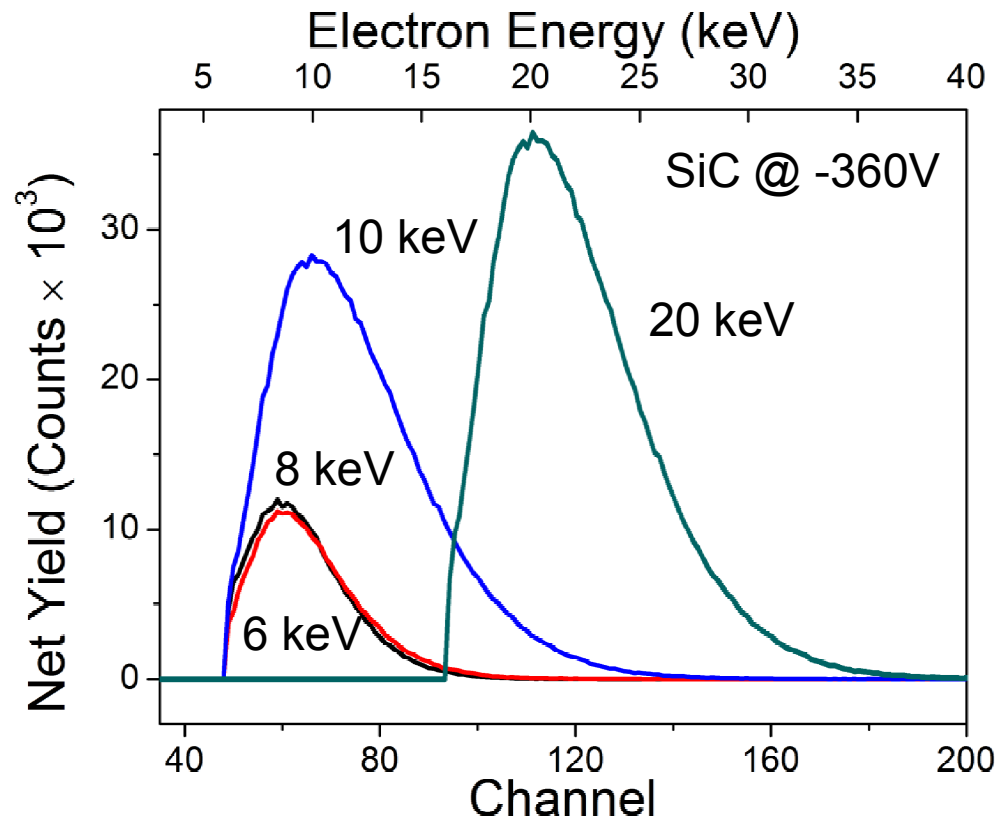
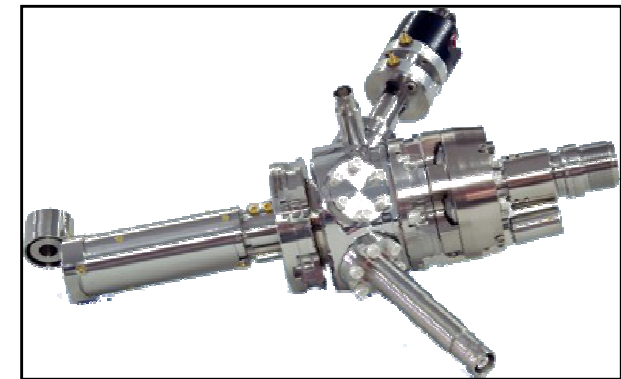
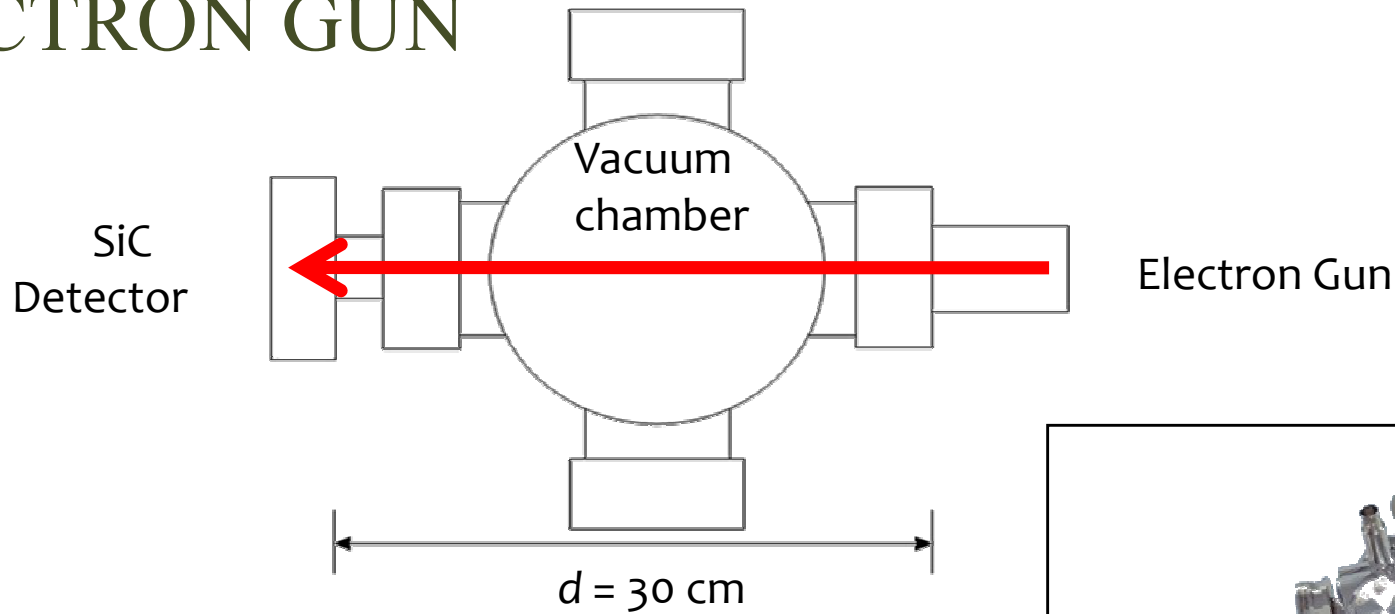


# ENERGY RESOLUTION



- Centroid
- Full Width Half Maximum (FWHM)

# ELECTRON GUN



Kimball Physics  
Electron Gun Systems  
EGG-3101 Model

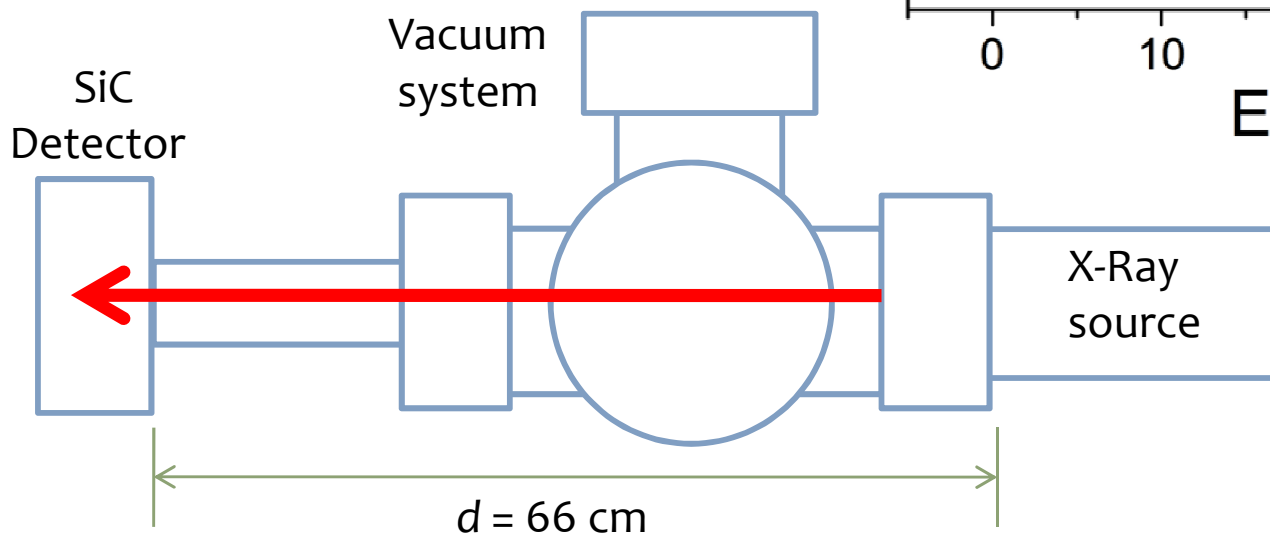
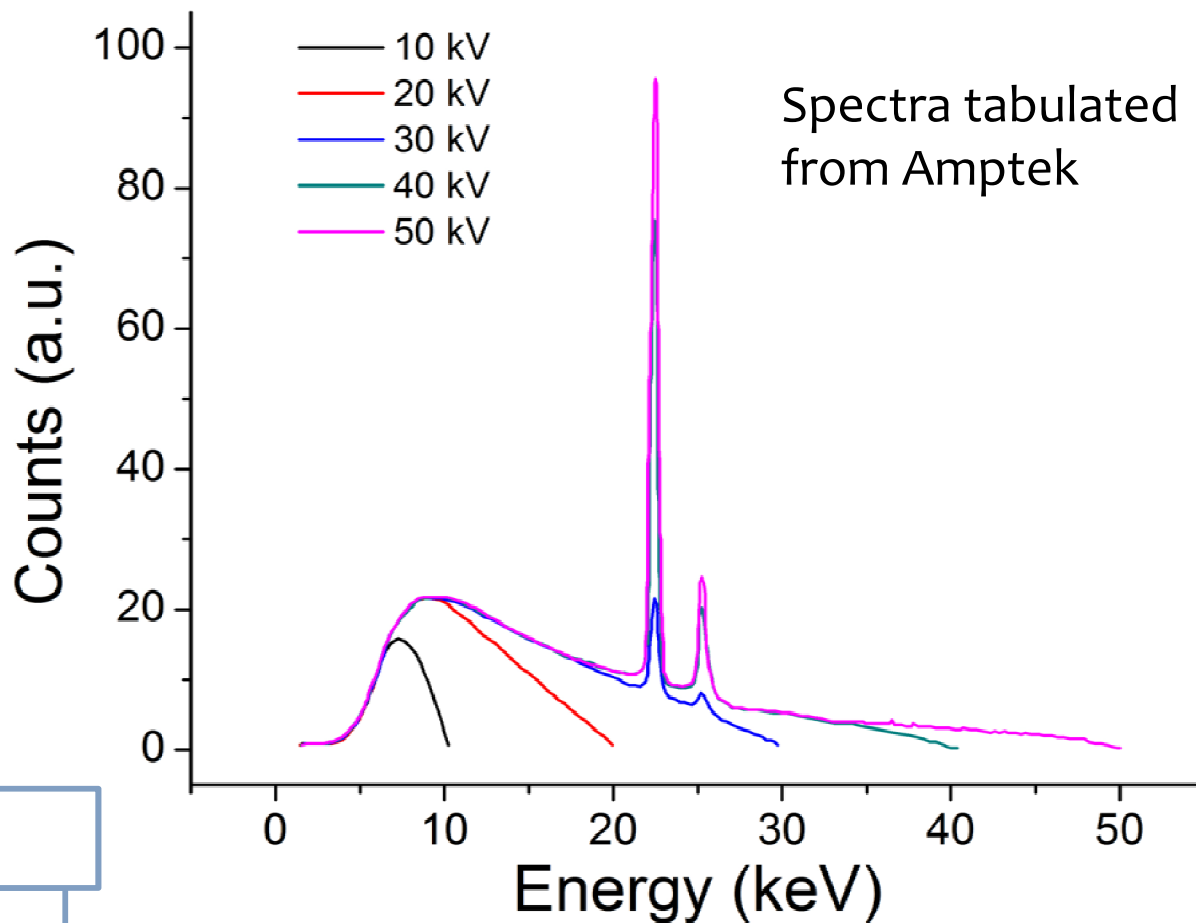
Energy: 100 eV - 20 keV  
Beam current: 10 nA - 100  $\mu$ A

Acquisition time 300 s

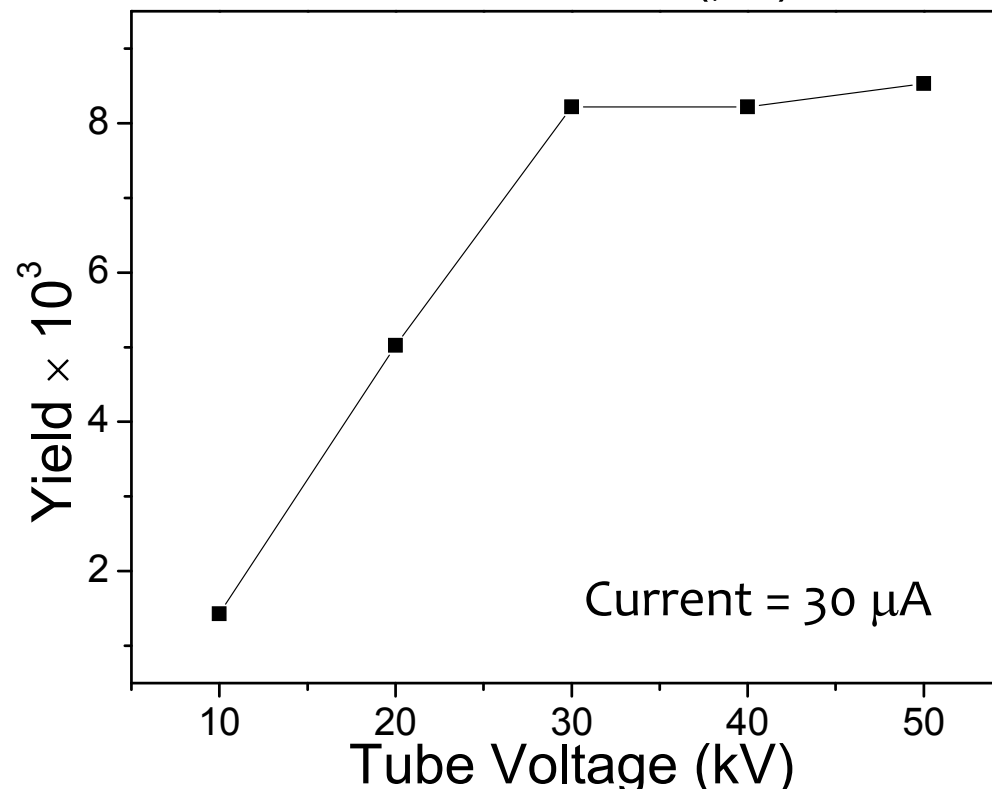
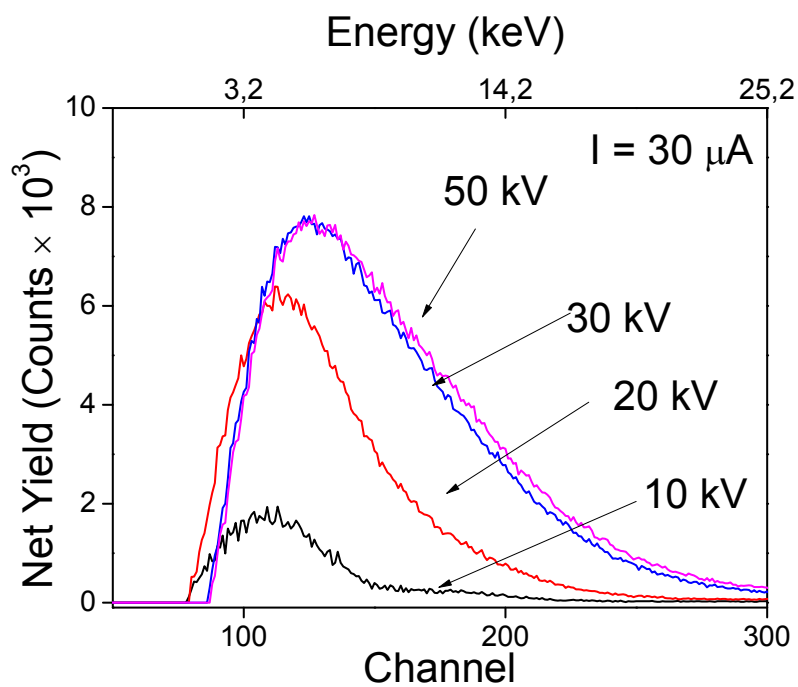
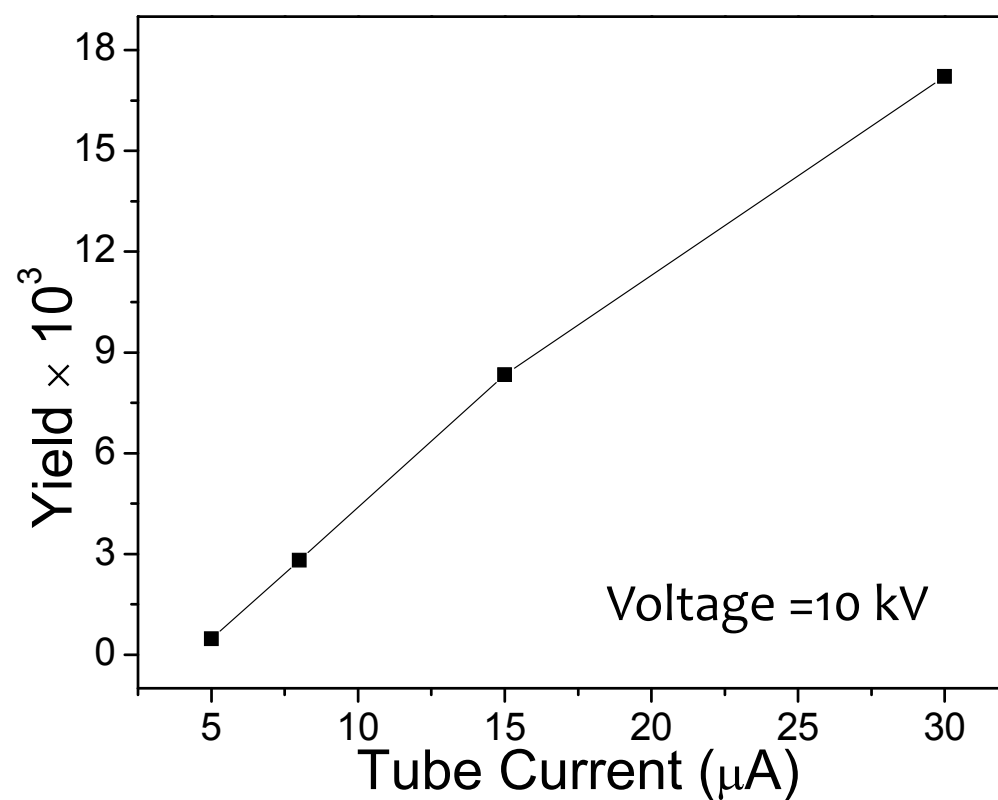
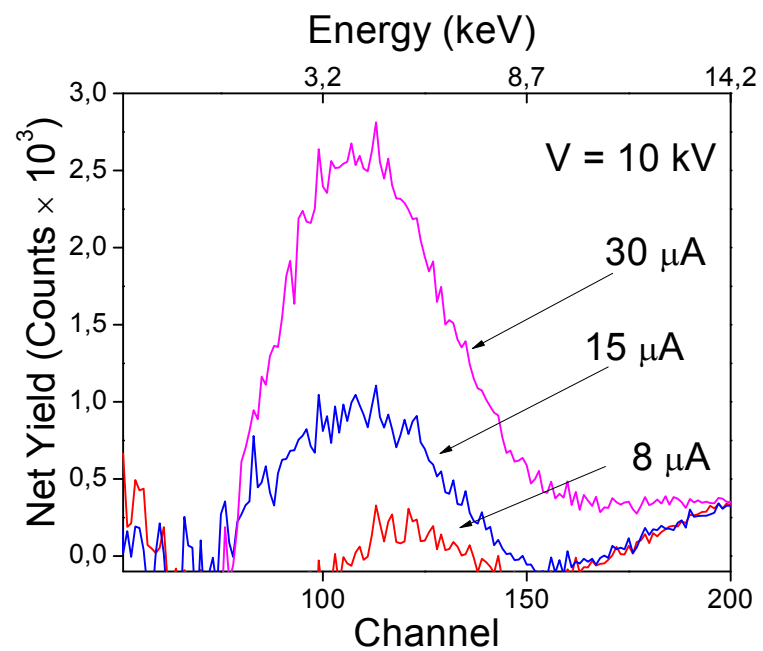
# X-RAY MEASUREMENTS (AMPTEK)



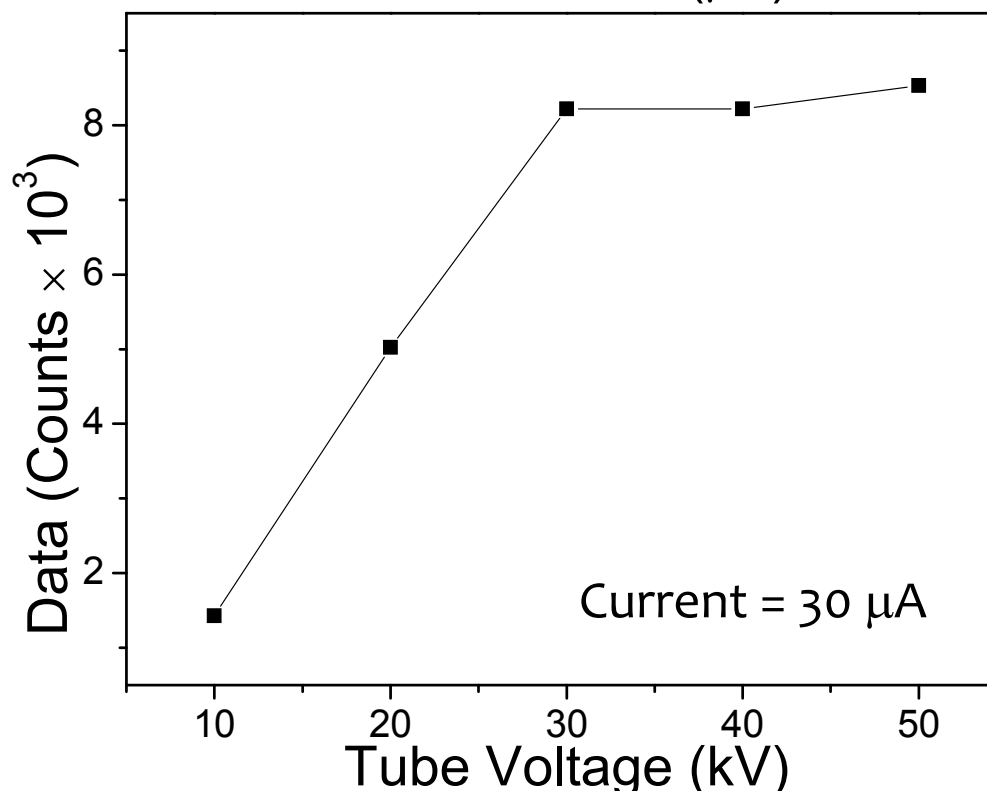
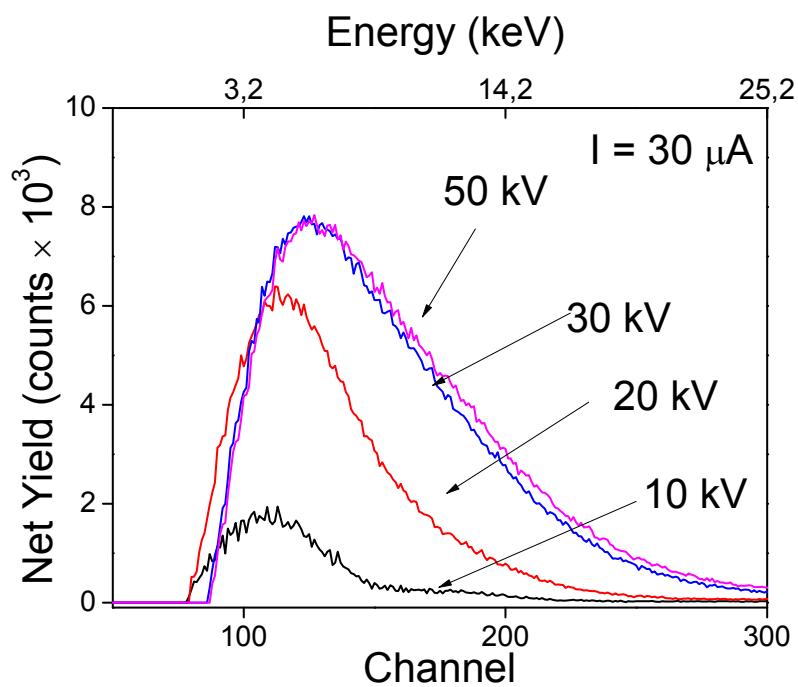
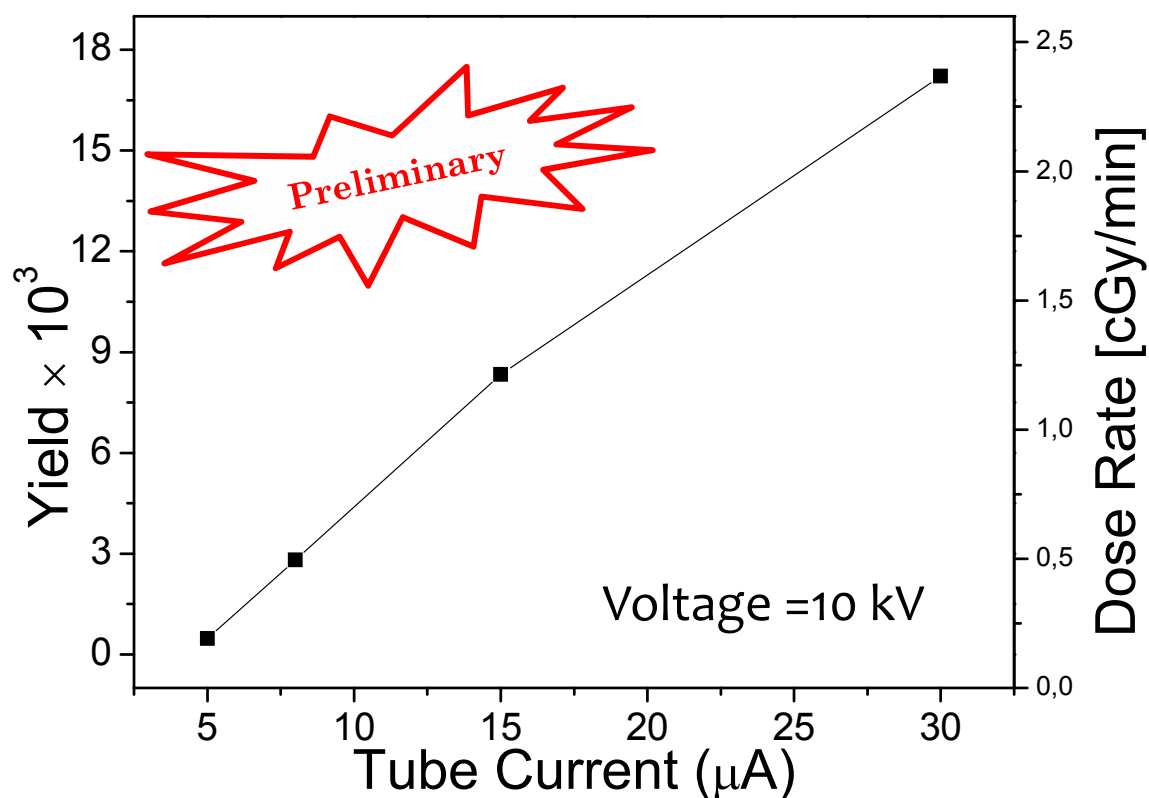
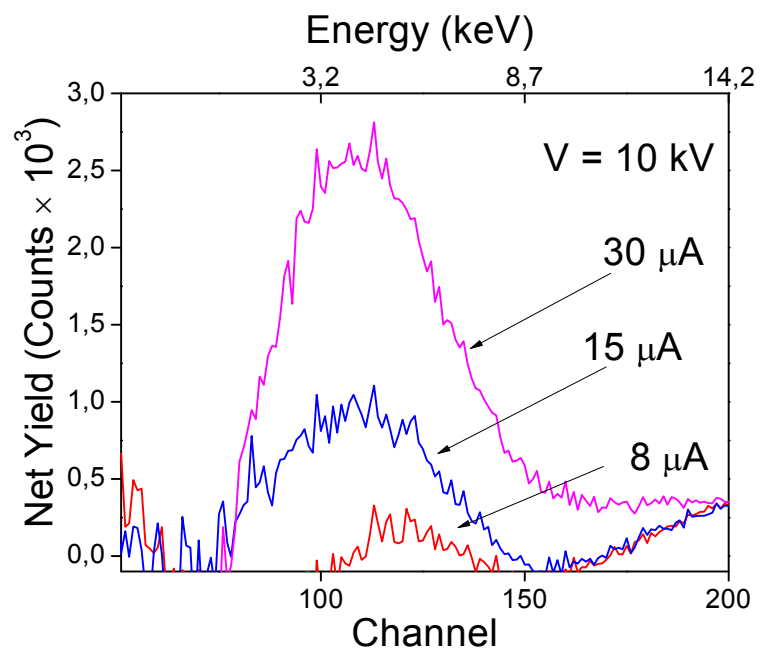
Mini X-Ray Tube  
Tube voltage 1-50 kV  
Tube current 5-80  $\mu\text{A}$   
Silver Target



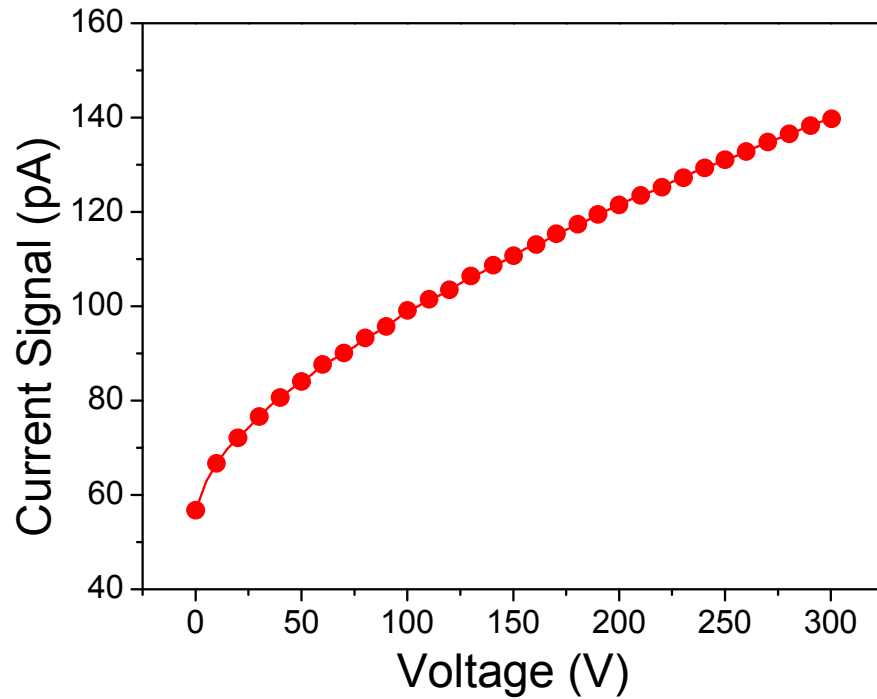
# RESULTS



# RESULTS

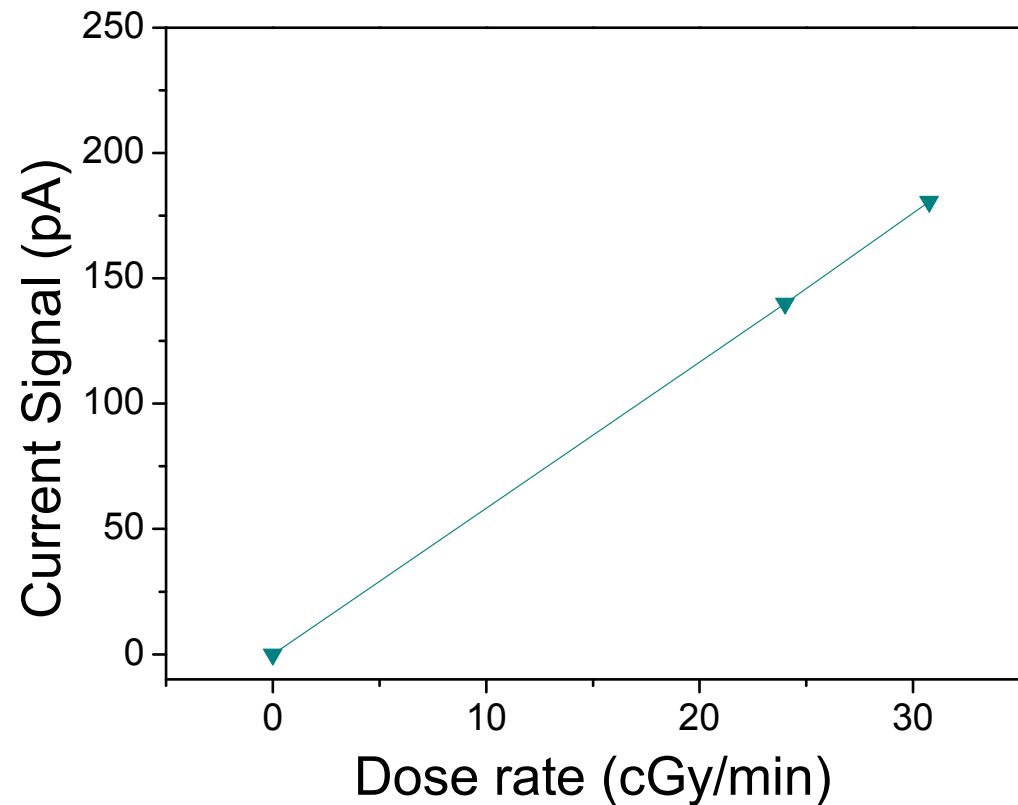


# APPLICATION IN RADIATION DOSIMETRY



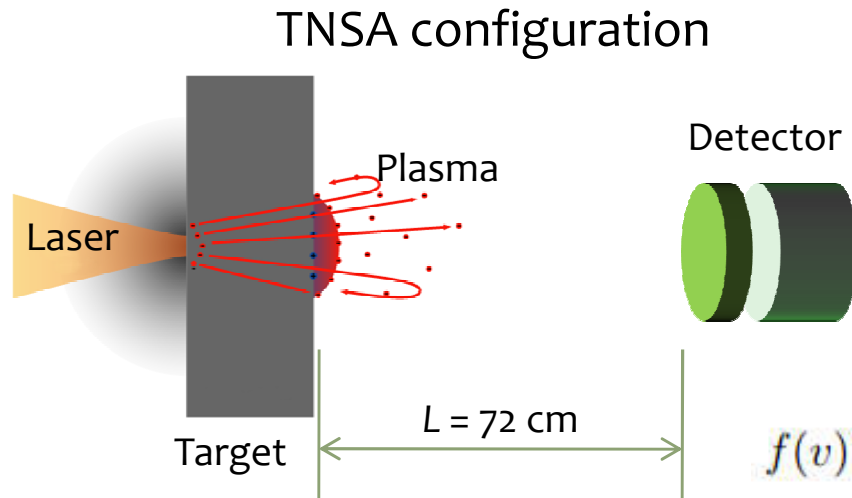
Source  $^{60}\text{Co}$  (1.3 + 1.1 MeV)  
SiC @ - 300 V  
Dose Rate 0.24 Gy/min

Source  $^{60}\text{Co}$   
SiC @ - 300 V



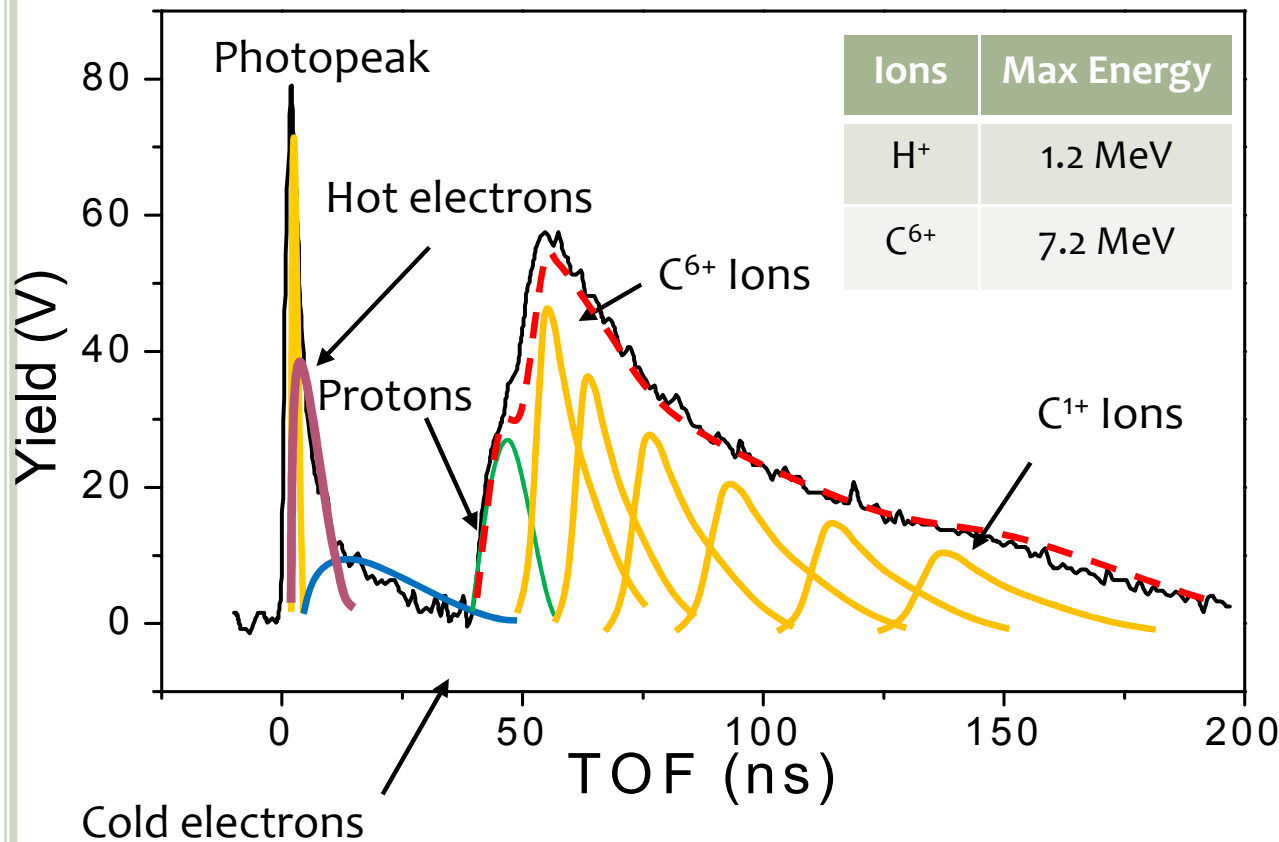


# RADIATION EMITTED BY PLASMA-LASER



**C**oulomb  
**B**oltzmann  
**S**hifted

$$f(v) = A \sqrt{\left(\frac{m}{2\pi k_B T}\right)^3} v^3 \exp\left[-\left(\frac{m}{2k_B T}\right)(v - v_k - v_c)^2\right]$$



PALS laboratory:  
 Iodine laser  
 Laser wavelength 1315 nm  
 Pulse energy 600 J  
 Pulse duration 300 ps  
 Intensity  $10^{15} \text{ W cm}^{-2}$

Target-detector  $L = 72 \text{ cm}$   
 Targets Polyethylene PE  
 Target thickness  $10 \mu\text{m}$

# CONCLUSIONS

SiC detector offers many advantages:

- The SiC detector with 80  $\mu\text{m}$  depth active region allows to investigate hard X-rays, energetic electrons ( $\sim 300$  keV) and high ion energy ( $\sim$  tens MeV);
- At low fluence a readout electronics in regime of proportionality to the energy radiation could be employed;
- Good linearity, efficiency, energy resolution comparable to Si (SSB) detector;
- In TOF regime SiC detector can be employed to detect high fluence radiation such those emitted from laser generated plasmas;
- More information can be extracted such as the ion energy distribution from plasma by using a Coulomb Boltzmann Shifted function distribution to deconvolve the TOF SiC spectra.
- The advantages to use SiC detectors instead than Si detector are due to the possibility to be employed in presence of high intensity visible light, to be employed at room temperature with a very low dark current of the order of 10 pA, the possibility to have higher sensitivity due to their linear response to the dose rate also using very low dose rates of the order of one cGy/min for photons



# REFERENCE

- [1] L. Torrasi, M. Cutroneo, G. Ceccio, A. Cannavò et al., Near monochromatic 20 Me V proton acceleration using fs laser irradiating Au foils in target normal sheath acceleration regime, Phys. Plasmas 23, 043102 (2016)
- [2] A. Cannavò, L. Torrasi, L. Calcagno, Energy resolution comparison between Si and SiC detectors, PhD Activity report 2014, ISSN 2038-5889
- [3] A. Cannavò, L. Torrasi, Advanced SiC detectors for laser-generated plasma diagnostic, PhD Activity report 2015, ISSN 2038-5889
- [4] L. Torrasi and A. Cannavò, SiC detector damage and characterization for high intensity laser-plasma diagnostics 2016 JINST 11 P05009
- [5] L. Torrasi, A. Sciuto, L. Calcagno et al., Laser-plasma X-ray detection by using fast 4H-SiC interdigit and ion collector detectors 2015 JINST 10 P07009
- [6] A. Cannavò, L. Torrasi, L. Calcagno, SiC detector characterization for radiation emitted by laser-generated plasmas, 2016 JINST 11 C05008



# PARTICULAR THANKS TO

CNR IMM, Catania

ST Microelectronics, Catania

Dipartimento di Fisica, Catania

Dipartimento di Fisica, Messina

PALS laboratory, Prague

**Thank you for the  
attention**



STMicroelectronics



# Time-of-flight Regime

